



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# PCN20130327000
Additional Pb Free Lead Finish and expansion of capacity
(ASE-Shanghai) for Selected SOIC (D) products.
Change Notification / Sample Request

Date: 3/28/2013
To: MOUSER PCN

Dear Customer:

This is an announcement of change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

We request you acknowledge receipt of this notification within **30** days of the date of this notice. If you require samples to conduct an evaluation, please make any request within the 30 days—samples are not built ahead of the change. Please see the schedule on the following pages for availability dates. You may contact the PCN Manager or your local Field Sales Representative to acknowledge this PCN and request samples.

The changes discussed within this PCN will not take effect any earlier than **90** days from the date of this notification, unless customer agreement has been reached on an earlier implementation of the change. This notification period is per TI's standard process. Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services
Phone: +1(214) 480-6037
Fax: +1(214) 480-6659

20130327000
Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TL431ACD	null
TL431ACDR	null
TL431AID	null
TL431AIDR	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20130327000			PCN Date:	03/28/2013
Title:	Additional Pb Free Lead Finish and expansion of capacity (ASE-Shanghai) for Selected SOIC (D) products.				
Customer Contact:	PCN_ww_admin_team@list.ti.com		Phone:	+1(214)480-6037	Dept: Quality Services
Proposed 1st Ship Date:		06/28/2013	Estimated Sample Availability:		As stated below
Change Type:					
<input checked="" type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Assembly Materials
<input type="checkbox"/>	Design	<input type="checkbox"/>	Electrical Specification	<input type="checkbox"/>	Mechanical Specification
<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>	Wafer Bump Site	<input type="checkbox"/>	Wafer Bump Material	<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>	Wafer Fab Site	<input type="checkbox"/>	Wafer Fab Materials	<input type="checkbox"/>	Wafer Fab Process
PCN Details					
Description of Change:					
<p>Texas Instruments is pleased to announce flexibility of supply with the qualification of Matte Sn finish as an additional Lead Free (Pb Free) Leadframe finish and expansion of capacity by qualifying ASE-Shanghai (China) facility for selected SOIC devices.</p> <p>ASE-Shanghai is a qualified Assembly and Test site for Texas Instruments (PCN# 20100218001)</p> <p>Upon expiry of this PCN TI will combine lead free solutions in a single <u>standard part number</u>, for example; <u>ULN2003ADR</u> – can ship with both Matte Sn and NiPdAu/Ag.</p> <p>Example:</p> <ul style="list-style-type: none"> – Customer order for 7500units of ULN2003APWR with 2500 units SPQ (Standard Pack Quantity per Reel). – TI can satisfy the above order in one of the following ways. <ul style="list-style-type: none"> I. 3 Reels of NiPdAu finish. II. 3 Reels of Matte Sn finish III. 2 Reels of Matte Sn and 1 reel of NiPdAu finish. IV. 2 Reels of NiPdAu and 1 reel of Matte Sn finish. <p>Note: TI part numbers with "G4" or "G3" suffix are <u>NOT</u> affected by this PCN, for example ULN2003ADRG4 or ULN2003ADRG3.</p>					
Reason for Change:					
<p>Continuity of supply.</p> <p>Improve customer service with supply flexibility and improved lead times.</p>					
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):					
TI does not anticipate any negative impact from this change.					

Changes to product identification resulting from this PCN:

TI will maintain traceability and identification per JEDEC guidelines.

There is **No Change** in product identification and packing labels. TI will continue to follow the J-STD-609 industry standard to identify Pb Free Leadframe Finish options on packaging label and package symbolization.

Customers will be able to clearly identify Leadframe finish from the ECAT code on package symbolization and labels.

Package symbolization:

No Change to package level symbolization. Symbolization contains the recommended ECAT symbol in addition to TI Lot Trace Code and device name.

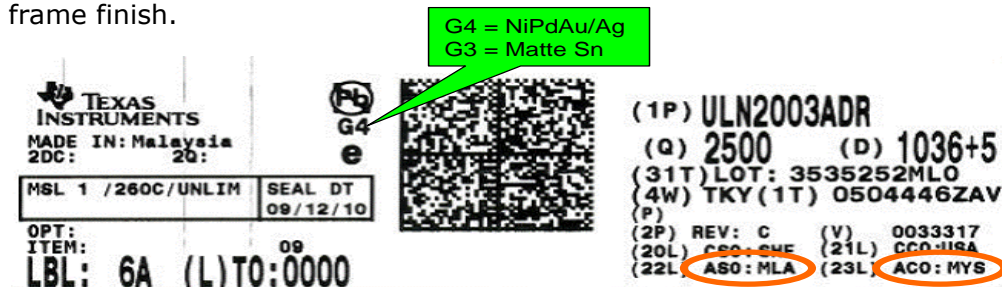
G4 = Green products with NiPdAu/Ag Lead Finish

G3 = Green products with Matte Sn lead finish.



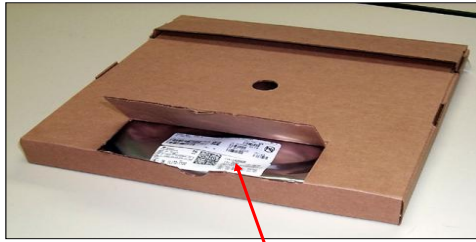
Packing/shipping Label

No change to TI Manufacturing Label and Customer Label (if applicable). Each reel, pizza boxes and standard packing boxes includes the correct ECAT symbols based on the appropriate lead frame finish.



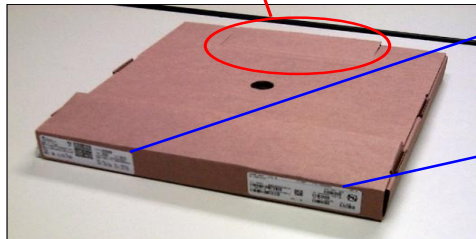
Each "pizza box" and reel will carry the appropriate label clearly identifying lead finish as described above.

• Shipping Label– No Change



Manufacturing Label

The Manufacturing Label is applied by the Assembly/Test site on the moisture barrier bag or directly to the reel



Customer Label

The Customer Label is applied by the PDC on the moisture barrier bag or directly to reel above the Manufacturing Label

TI Information – Selective Disclosure

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Note: ASE-Shanghai will have the site code (ASO) and country of origin code (ACO) below.

Assembly site Origin Code (22L)	Assembly country Origin Code (23L)
ASH	CHN

Products Affected:

TL431ACD	TL431ACDR	TL431AID	TL431AIDR
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Qualification Data			
Qual Vehicle 1: ULN2003AD			
Construction Details			
Assembly Site:	ASE Shanghai	Mold Compound:	SID#EN2000509
# Pins-Designator, Family:	16-D, SOIC	Mount Compound:	SID#EY1000063
Leadframe (Finish, Base):	Sn	Bond Wire:	0.8 Mil Dia. Au
Fab Process	JI Bipolar	Wafer Fab	SHE

Qualification: <input type="checkbox"/> Plan <input checked="" type="checkbox"/> Test Results			
Reliability Test		Conditions	Sample Size (PASS/FAIL)
			3 Lots
*Steady State Life Test		300 Hrs	77/0, 77/0, 77/0
*Thermal Shock		1000 cycles	77/0, 77/0, 77/0
*Biased Hast		96 Hrs	77/0, 77/0, 77/0
*High Temp Storage Bake		150C, 1000 Hrs	77/0, 77/0, 77/0
*Temperature Cycle		-65C/150C, 1000 cycles	77/0, 77/0, 77/0
*Autoclave		96 Hrs	77/0, 77/0, 77/0
Salt Atmosphere		-	22/0, 22/0, 22/0
Flammability		(UL-1694)	5/0, 5/0, 5/0
Flammability		(UL-94V-0)	5/0, 5/0, 5/0
Flammability		(IEC 695-2-2)	5/0, 5/0, 5/0
Moisture Sensitivity		MSL 1 / 260C	12/0, 12/0, 12/0
Physical Dimensions		Per mechanical drawing	5/0, 5/0, 5/0
Bond Strength		76 Ball Bonds	76/0, 76/0, 76/0
Die Shear		-	15/0, 15/0, 15/0
Lead Fatigue		-	22/0, 22/0, 22/0
Lead Pull		-	22/0, 22/0, 22/0
Lead Finish Adhesion		-	15/0, 15/0, 15/0
Solderability		8 Hrs/Steam Age	22/0, 22/0, 22/0
X-Ray		Top Side Only	5/0, 5/0, 5/0
Visual mechanical		Approved by AT Site	Pass
Electrical Test Manufacturability-TQ		Approved by AT Site & Product Engineer	Pass
Qual Vehicle 2: HC04DR			
Construction Details			
Assembly Site:		ASE-Shanghai	Mold Compound: SID#EN2000511
# Pins-Designator, Family:		14-D, SOIC	Mount Compound: SID#EY1000063
Leadframe (Finish, Base):		Sn	Bond Wire: Au
Fab Process		HCMOS	Wafer Fab SHE
Qualification: <input type="checkbox"/> Plan <input checked="" type="checkbox"/> Test Results			
Reliability Test		Conditions	Sample Size (PASS/FAIL)
			3 Lots
*High Temp Storage Bake		150C, 1000 Hrs	77/0, 77/0, 77/0
*Temperature Cycle		-65C/150C, 1000 cycles	77/0, 77/0, 77/0
Bond Strength		76 Ball Bonds	76/0, 76/0, 76/0
Die Shear		-	15/0, 15/0, 15/0
Visual mechanical		Approved by AT Site	Pass
X-Ray		Top Side Only	5/0, 5/0, 5/0
Assembly Manufacturability		Approved by AT Site	Pass
Electrical Test Manufacturability-TO		Approved by AT Site & Product Engineer	Pass

Qual Vehicle 3: LM358AD			
Construction Details			
Assembly Site:	ASE-Shanghai	Mold Compound:	SID#EN2000509
# Pins-Designator, Family:	8-D, SOIC	Mount Compound:	SID#EY1000063
Leadframe (Finish, Base):	Sn	Bond Wire:	Au
Fab Process	JI Bipolar	Wafer Fab	SHE
Qualification: <input type="checkbox"/> Plan <input checked="" type="checkbox"/> Test Results			
Reliability Test	Conditions	Sample Size (PASS/FAIL)	
		3 Lots	
Bond Strength	76 Ball Bonds	76/0, 76/0, 76/0	
Die Shear	-	15/0, 15/0, 15/0	
Visual mechanical	Approved by AT Site	Pass	
X-Ray	Top Side Only	5/0, 5/0, 5/0	
Assembly Manufacturability	Approved by AT Site	Pass	
Electrical Test Manufacturability-TQ	Approved by AT Site & Product Engineer	Pass	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com